

Enhancement Mode N-Channel Power MOSFET

Features

- ◆ Low $R_{DS(on)}$ & FOM
- ◆ Extremely low switching loss
- ◆ Excellent stability and uniformity
- ◆ Easy to drive

Applications

- ◆ Lighting
- ◆ Hard switching PWM
- ◆ Server power supply
- ◆ Charger

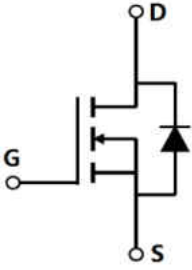



General Description

OSG65R760xF use advanced GreenMOSTM technology to provide low $R_{DS(ON)}$, low gate charge, fast switching and excellent avalanche characteristics. This device is suitable for active power factor correction and switching mode power supply applications.

◆ $V_{DS, min@Tjmax}$	700 V
◆ $I_{D, pulse}$	21 A
◆ $R_{DS(ON), max @ V_{GS}=10 V}$	760 mΩ
◆ Q_g	7.4 nC

Schematic and Package Information

Schematic Diagram 	Pin Assignment Top View 										
	<table border="0"> <tr> <td>TO251</td> <td>TO252</td> <td>TO220F</td> <td>TO220</td> <td>TO262</td> </tr> <tr> <td>OSG65R760AF</td> <td>OSG65R760DF</td> <td>OSG65R760FF</td> <td>OSG65R760PF</td> <td>OSG65R760IF</td> </tr> </table>	TO251	TO252	TO220F	TO220	TO262	OSG65R760AF	OSG65R760DF	OSG65R760FF	OSG65R760PF	OSG65R760IF
TO251	TO252	TO220F	TO220	TO262							
OSG65R760AF	OSG65R760DF	OSG65R760FF	OSG65R760PF	OSG65R760IF							

Absolute Maximum Ratings at $T_j=25^{\circ}C$ unless otherwise noted

Parameter	Symbol	Value	Unit
Drain source voltage	V_{DS}	650	V
Gate source voltage	V_{GS}	±30	V
Continuous drain current ¹⁾ , $T_C=25^{\circ}C$	I_D	7	A
Continuous drain current ¹⁾ , $T_C=100^{\circ}C$		4.4	
Pulsed drain current ²⁾ , $T_C=25^{\circ}C$	$I_{D, pulse}$	21	A
Power dissipation ³⁾ for TO251, TO252, TO220, TO262, $T_C=25^{\circ}C$	P_D	37	W
Power dissipation ³⁾ for TO220F, $T_C=25^{\circ}C$		26	
Single pulsed avalanche energy ⁵⁾	E_{AS}	130	mJ
MOSFET dv/dt ruggedness, $V_{DS}=0...480 V$	dv/dt	50	V/ns
Reverse diode dv/dt, $V_{DS}=0...480 V$, $I_{SD} \leq I_D$	dv/dt	15	V/ns
Operation and storage temperature	T_{stg}, T_j	-55 to 150	°C



■ Thermal Characteristics

Parameter	Symbol	Value		Unit
		TO251/TO252/TO220/TO262	TO220F	
Thermal resistance, junction-case	$R_{\theta JC}$	3.4	4.8	$^{\circ}\text{C}/\text{W}$
Thermal resistance, junction-ambient ⁴⁾	$R_{\theta JA}$	62	62.5	$^{\circ}\text{C}/\text{W}$

■ Electrical Characteristics at $T_j=25^{\circ}\text{C}$ unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Drain-source breakdown voltage	BV_{DSS}	650			V	$V_{GS}=0\text{ V}, I_D=250\ \mu\text{A}$
		700	750			$V_{GS}=0\text{ V}, I_D=250\ \mu\text{A}$ $T_j=150^{\circ}\text{C}$
Gate threshold voltage	$V_{GS(th)}$	2.0		4.0	V	$V_{DS}=V_{GS}, I_D=250\ \mu\text{A}$
Drain-source on-state resistance	$R_{DS(on)}$		0.66	0.76	Ω	$V_{GS}=10\text{ V}, I_D=3.5\text{ A}$
			1.6			$V_{GS}=10\text{ V}, I_D=3.5\text{ A},$ $T_j=150^{\circ}\text{C}$
Gate-source leakage current	I_{GSS}			100	nA	$V_{GS}=30\text{ V}$
				-100		$V_{GS}=-30\text{ V}$
Drain-source leakage current	I_{DSS}			1	μA	$V_{DS}=650\text{ V}, V_{GS}=0\text{ V}$

■ Dynamic Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Input capacitance	C_{iss}		354.2		pF	$V_{GS}=0\text{ V},$ $V_{DS}=50\text{ V},$ $f=1\text{ MHz}$
Output capacitance	C_{oss}		31.4		pF	
Reverse transfer capacitance	C_{rss}		1.54		pF	
Turn-on delay time	$t_{d(on)}$		17.6		ns	$V_{GS}=10\text{ V},$ $V_{DS}=400\text{ V},$ $R_G=25\ \Omega,$ $I_D=5\text{ A}$
Rise time	t_r		11.4		ns	
Turn-off delay time	$t_{d(off)}$		27.2		ns	
Fall time	t_f		24.4		ns	



■ Gate Charge Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Total gate charge	Q_g		7.4		nC	$I_D=5\text{ A}$, $V_{DS}=400\text{ V}$, $V_{GS}=10\text{ V}$
Gate-source charge	Q_{gs}		1.9		nC	
Gate-drain charge	Q_{gd}		3.3		nC	
Gate plateau voltage	V_{plateau}		5.9		V	

■ Body Diode Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Diode forward current	I_S			7	A	$V_{GS}<V_{th}$
Pulsed source current	I_{SP}			21		
Diode forward voltage	V_{SD}			1.3	V	$I_S=7\text{ A}$, $V_{GS}=0\text{ V}$
Reverse recovery time	t_{rr}		146		ns	$V_R=400\text{ V}$, $I_S=5\text{ A}$, $di/dt=100\text{ A}/\mu\text{s}$
Reverse recovery charge	Q_{rr}		0.98		μC	
Peak reverse recovery current	I_{rrm}		11.6		A	

■ Note

- 1) Calculated continuous current based on maximum allowable junction temperature.
- 2) Repetitive rating; pulse width limited by max. junction temperature.
- 3) P_d is based on max. junction temperature, using junction-case thermal resistance.
- 4) The value of $R_{\theta JA}$ is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with $T_a=25\text{ }^\circ\text{C}$.
- 5) $V_{DD}=50\text{ V}$, $R_G=25\text{ }\Omega$, $L=20\text{ mH}$, starting $T_j=25\text{ }^\circ\text{C}$.



■ Electrical Characteristics Diagrams

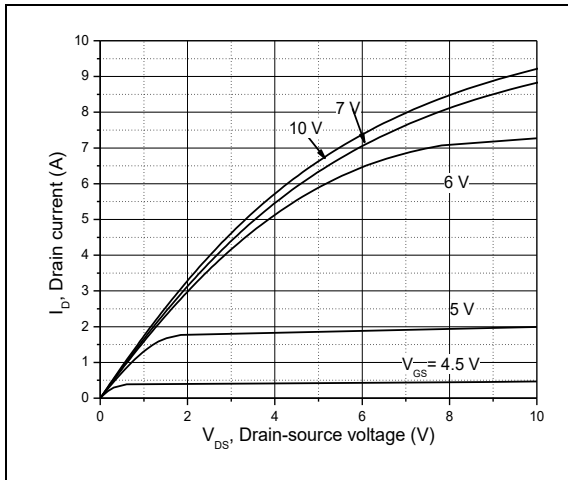


Figure 1, Typ. output characteristics

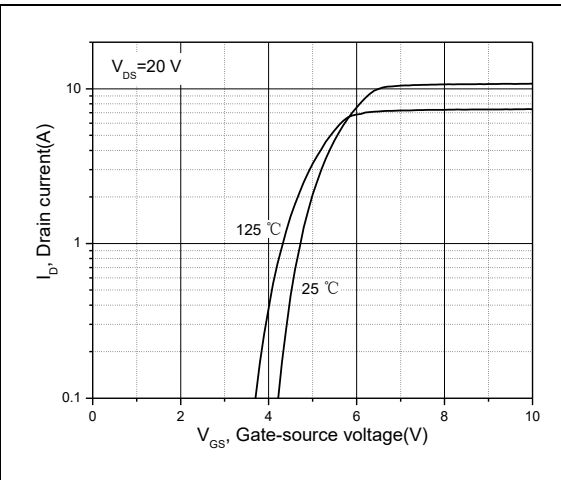


Figure 2, Typ. transfer characteristics

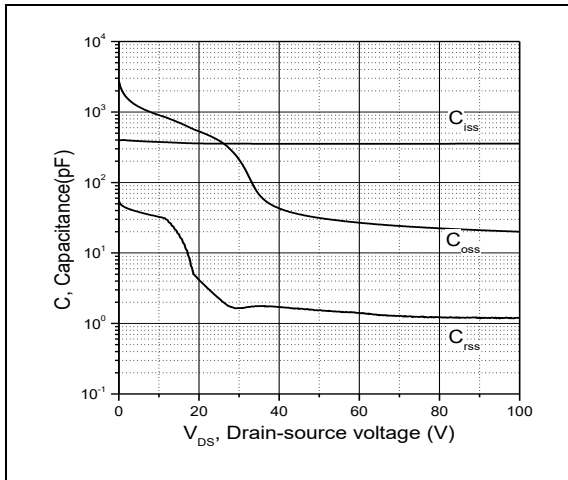


Figure 3, Typ. capacitances

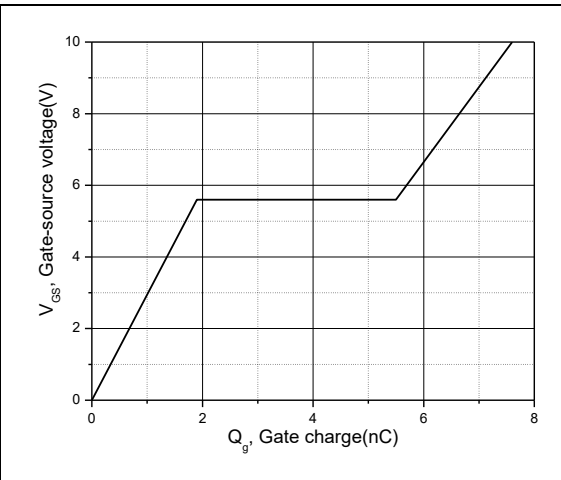


Figure 4, Typ. gate charge

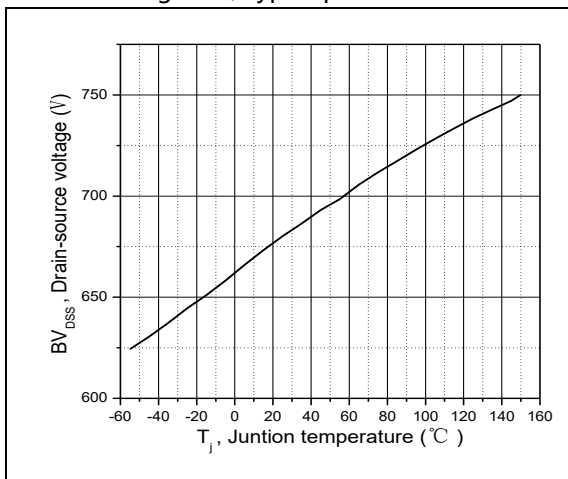


Figure 5, Drain-source breakdown voltage

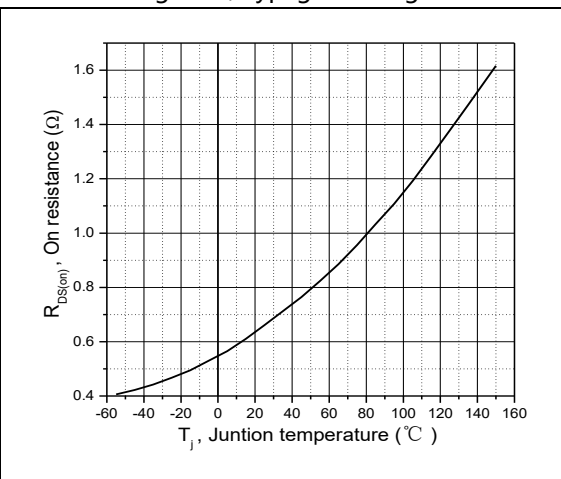


Figure 6, Drain-source on-state resistance

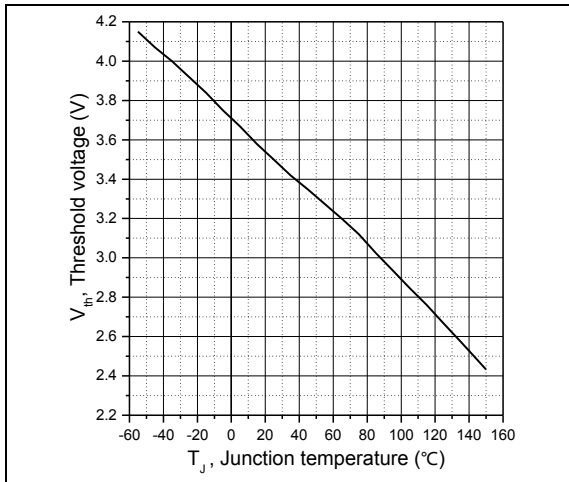


Figure 7, Threshold voltage

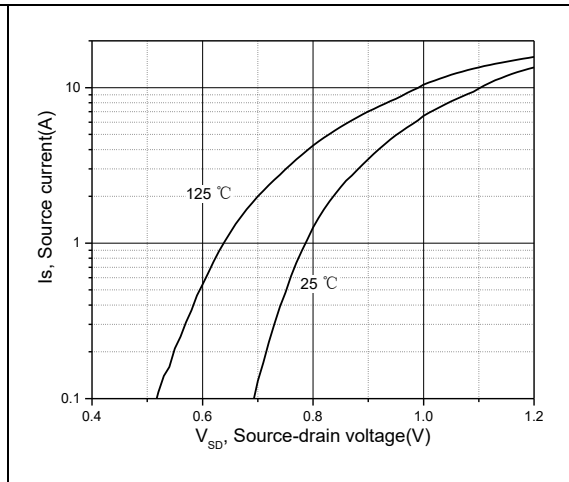


Figure 8, Forward characteristic of body diode

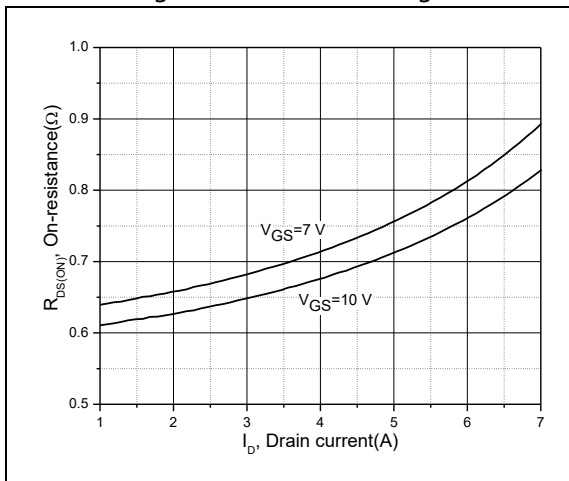


Figure 9, Drain-source on-state resistance

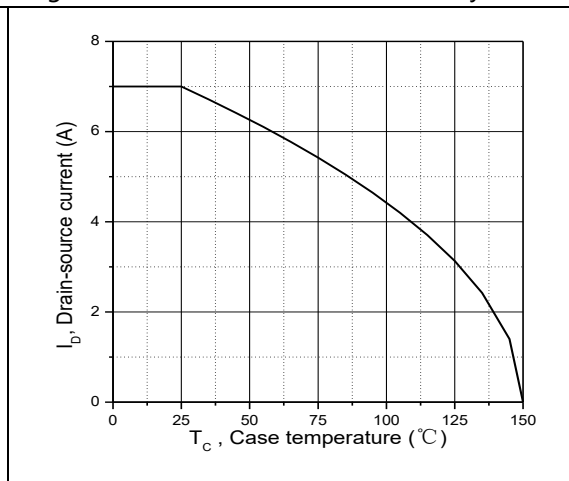


Figure 10, Drain current

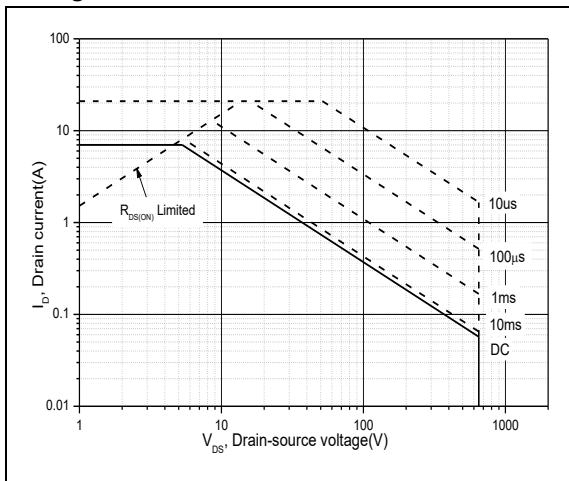


Figure 11, Safe operation area for TO251/TO252/TO220/TO262 $T_C=25\text{ }^\circ\text{C}$

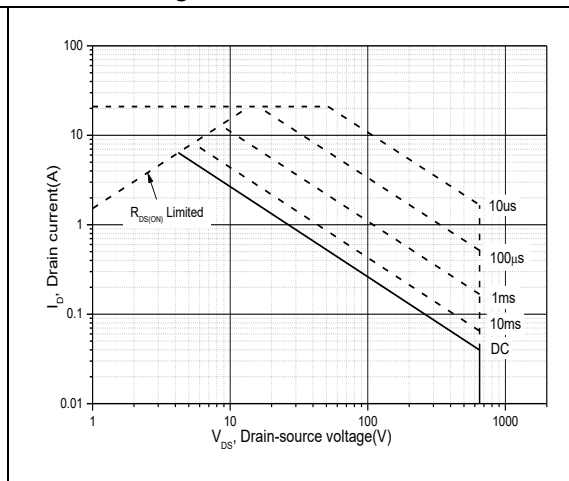
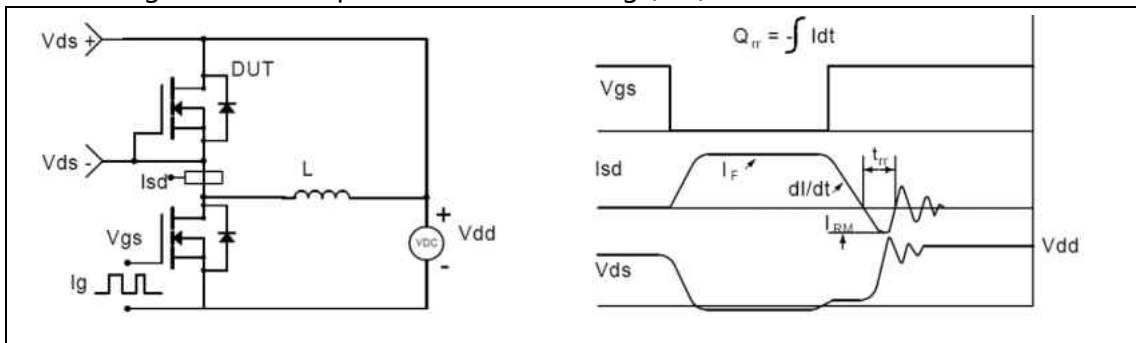
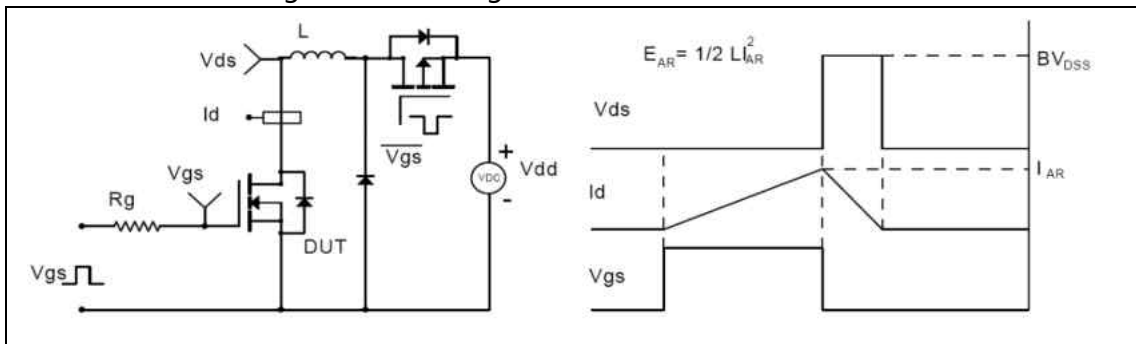
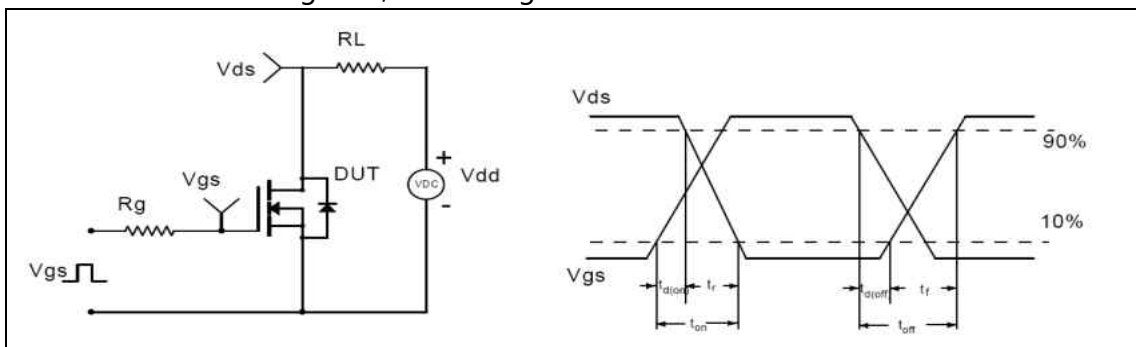
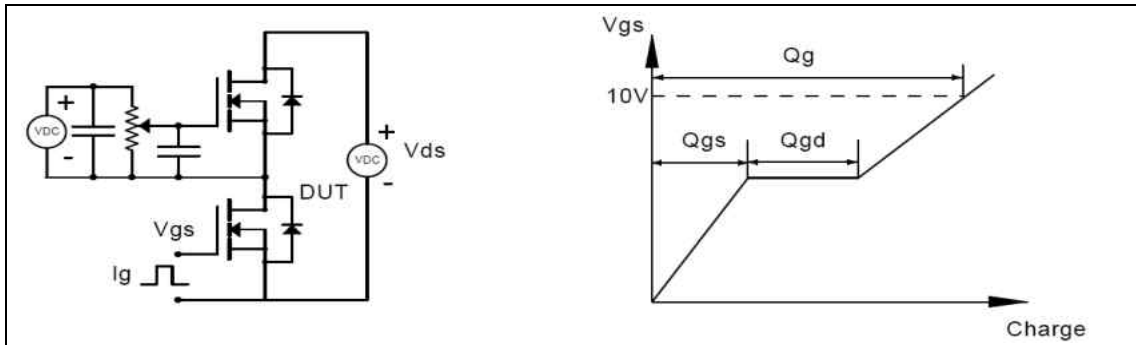


Figure 12, Safe operation area for TO220F $T_C=25\text{ }^\circ\text{C}$



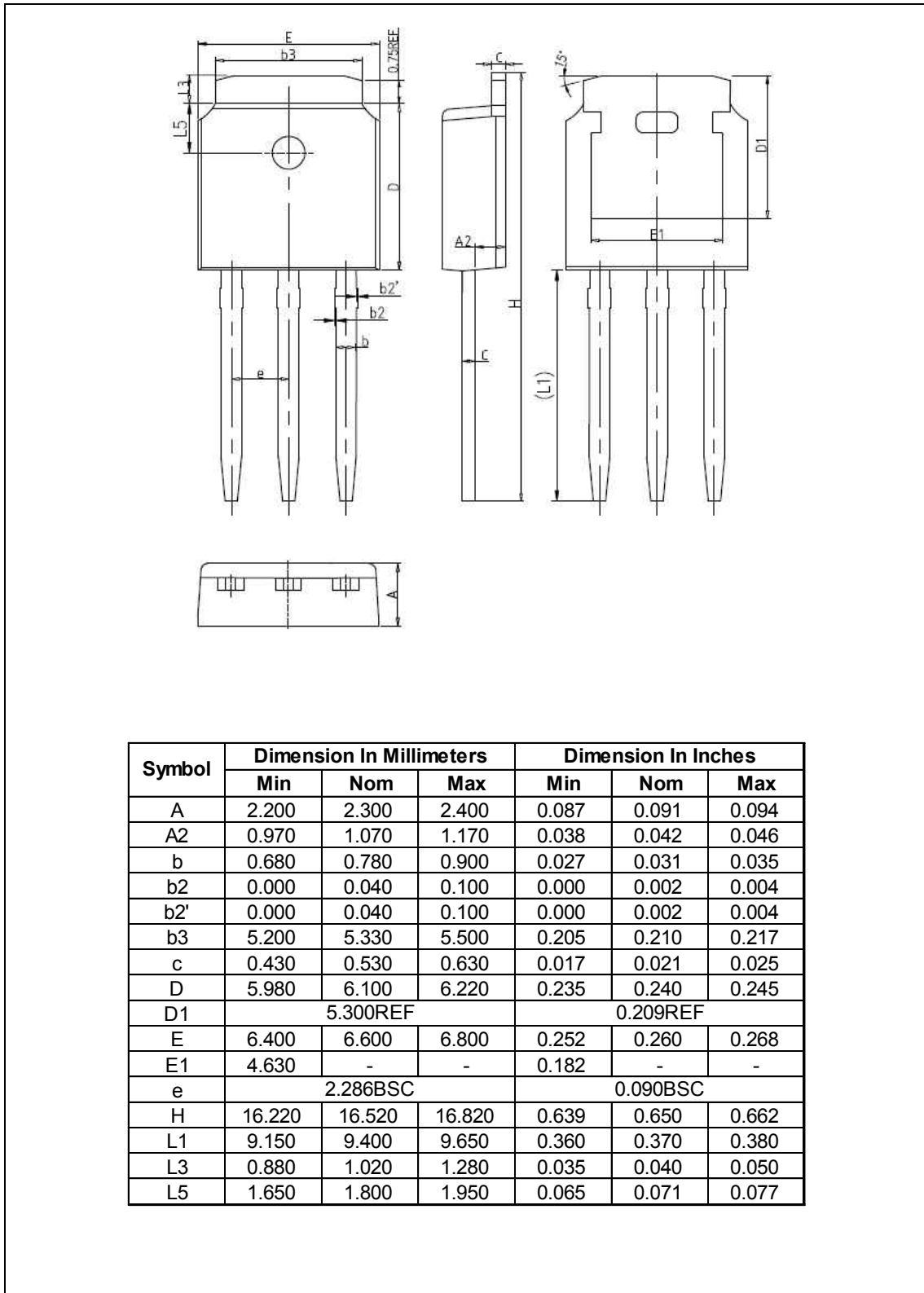
■ Test circuits and waveforms





■ Package Information

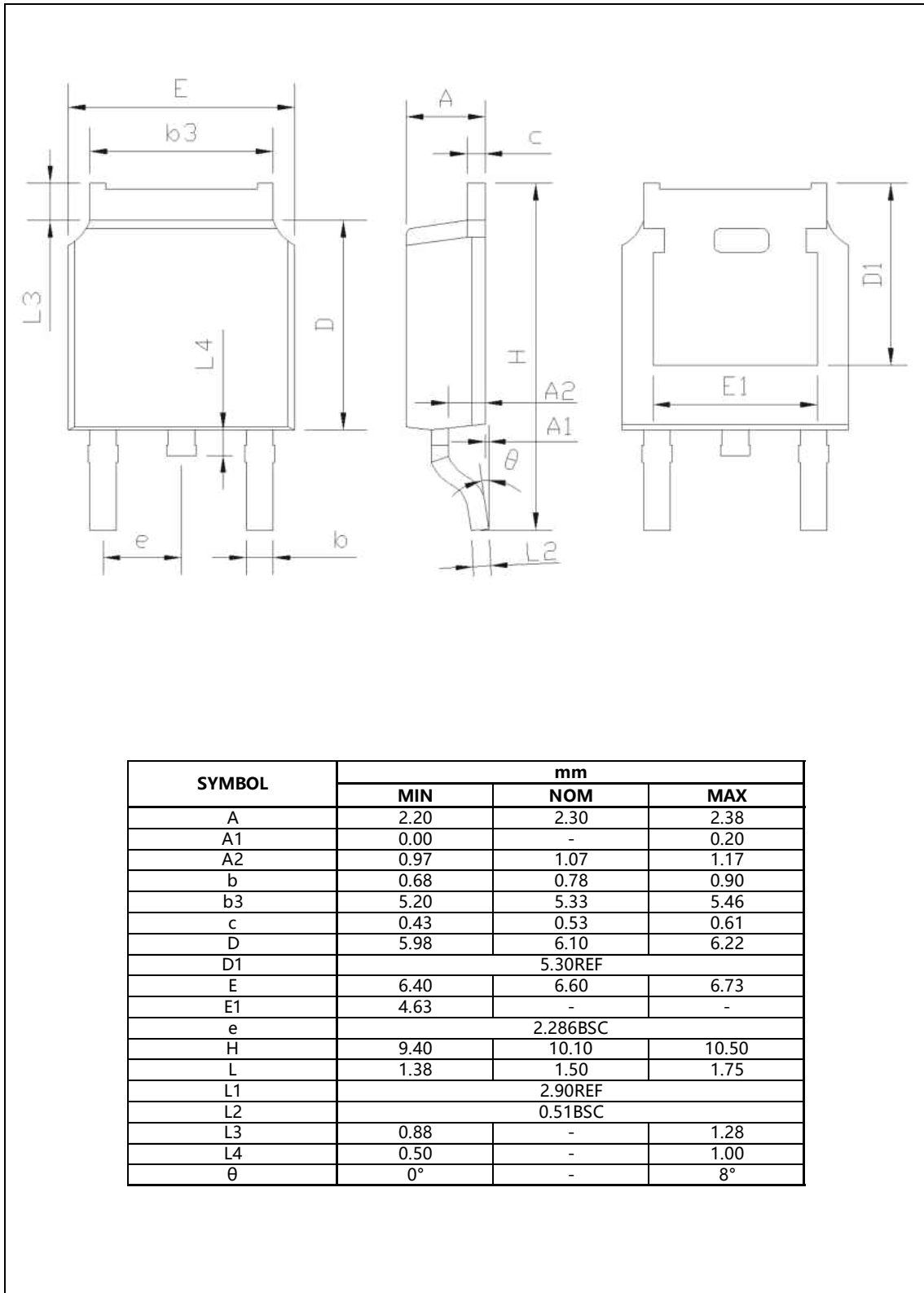
Figure1, TO251 package outline dimension





■ Package Information

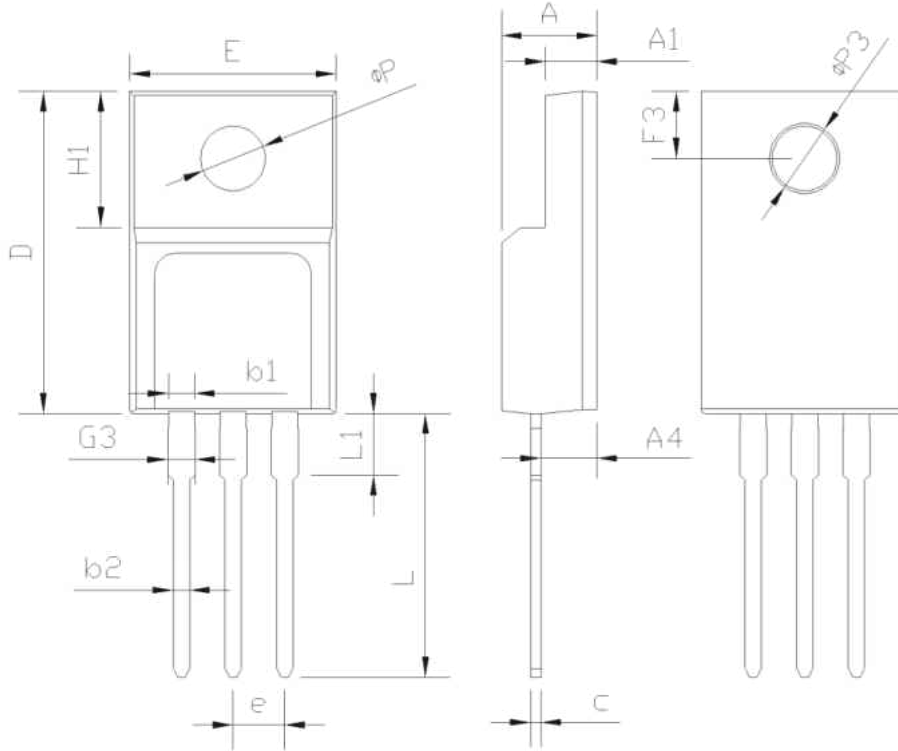
Figure2, TO252 package outline dimension





■ Package Information

Figure3, TO220F package outline dimension

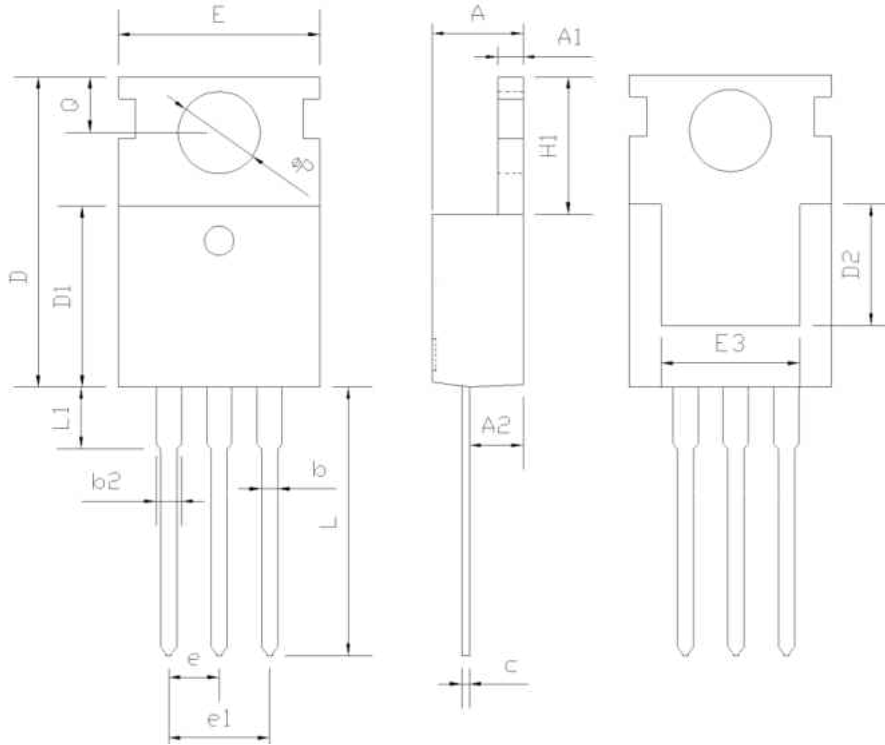


SYMBOL	mm		
	MIN	NOM	MAX
E	9.96	10.16	10.36
A	4.50	4.70	4.90
A1	2.34	2.54	2.74
A2	0.30	0.45	0.60
A4	2.56	2.76	2.96
c	0.40	0.50	0.65
c1	1.20	1.30	1.35
D	15.57	15.87	16.17
H1	6.70REF		
e	2.54BSC		
L	12.68	12.98	13.28
L1	2.88	3.03	3.18
ΦP	3.03	3.18	3.38
ΦP3	3.15	3.45	3.65
F3	3.15	3.30	3.45
G3	1.25	1.35	1.55
b1	1.18	1.28	1.43
b2	0.70	0.80	0.95



■ Package Information

Figure4, TO220 package outline dimension

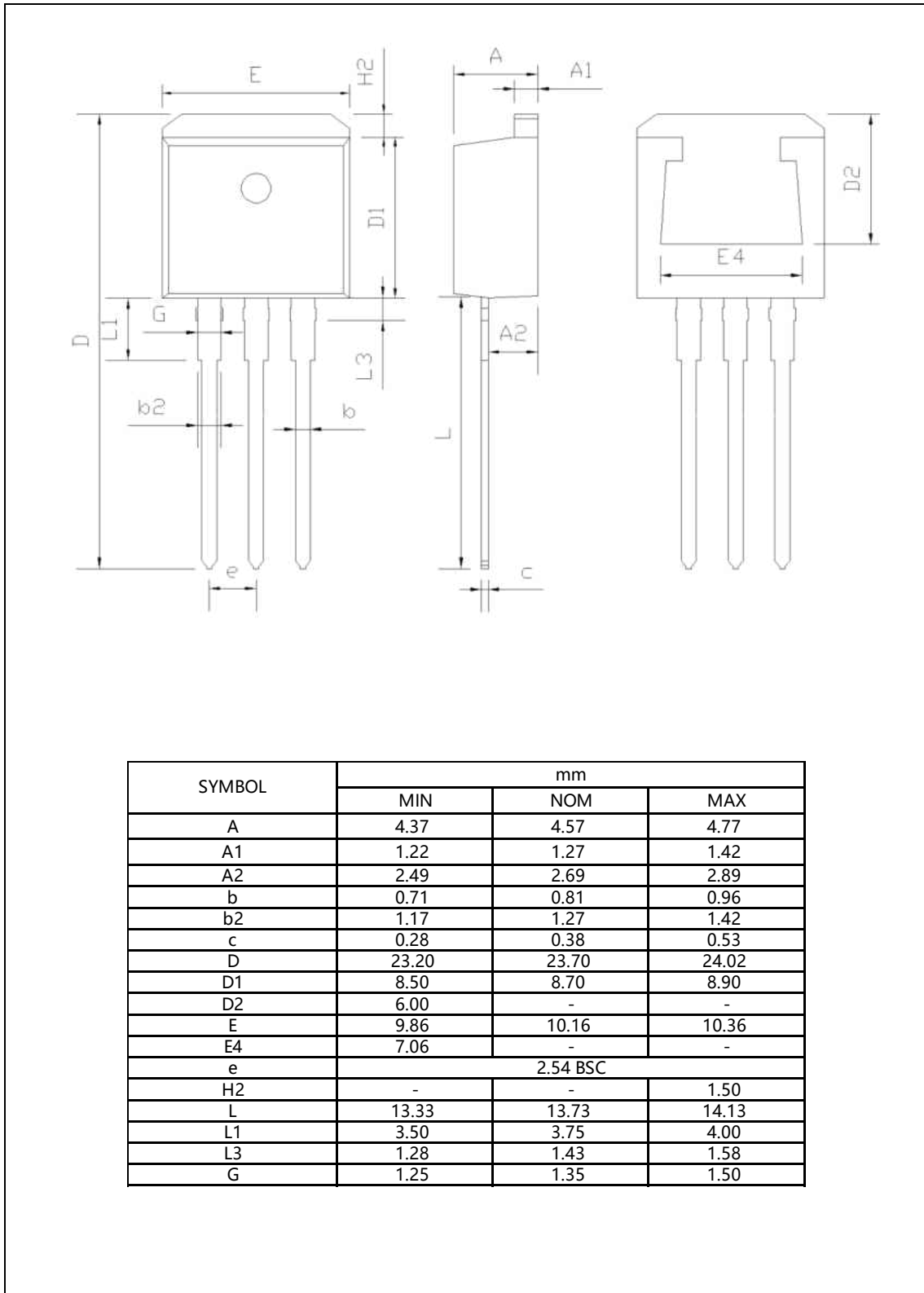


SYMBOL	mm		
	MIN	NOM	MAX
A	4.37	4.57	4.70
A1	1.25	1.30	1.40
A2	2.20	2.40	2.60
b	0.70	0.80	0.95
b2	1.17	1.27	1.47
c	0.45	0.50	0.60
D	15.10	15.60	16.10
D1	8.80	9.10	9.40
D2	5.50	-	-
E	9.70	10.00	10.30
E3	7.00	-	-
e	2.54 BSC		
e1	5.08 BSC		
H1	6.25	6.50	6.85
L	12.75	13.50	13.80
L1	-	3.10	3.40
ΦP	3.40	3.60	3.80
Q	2.60	2.80	3.00



■ Package Information

Figure5, TO262 package outline dimension





■ Ordering Information

Package	Units/Tube	Tubes/Inner Box	Units/Inner Box	Inner Box/Carton Box	Units/Carton Box
TO251	75	66	4950	6	29700
TO220F	50	20	1000	6	6000
TO220	50	20	1000	6	6000
TO262	50	20	1000	6	6000

Package	Units/Reel	Reels/Inner Box	Units/Inner Box	Inner Box/Carton Box	Units/Carton Box
TO252	2500	2	5000	5	25000

■ Product Information

Product	Package	Pb Free	RoHS	Halogen Free
OSG65R760AF	TO251	yes	yes	yes
OSG65R760DF	TO252	yes	yes	yes
OSG65R760FF	TO220F	yes	yes	yes
OSG65R760PF	TO220	yes	yes	yes
OSG65R760IF	TO262	yes	yes	yes